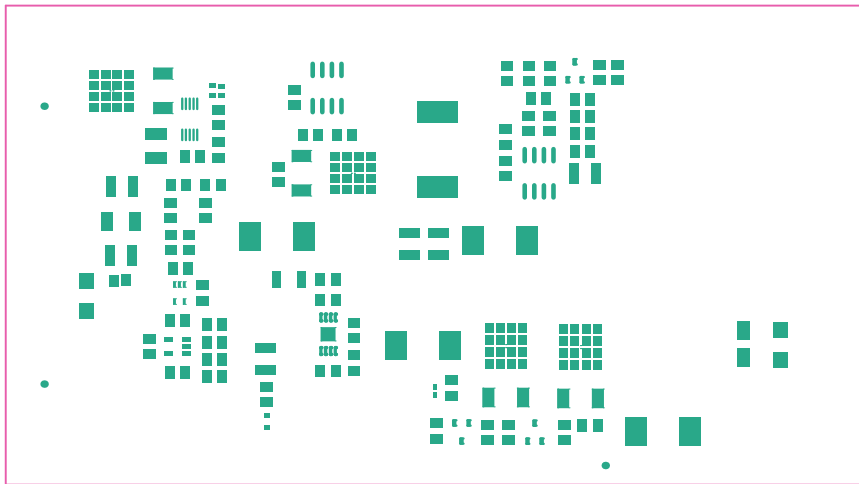
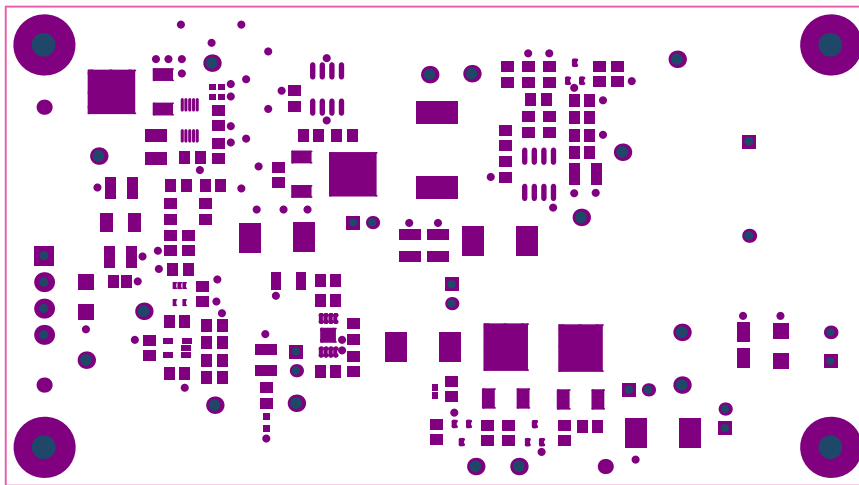


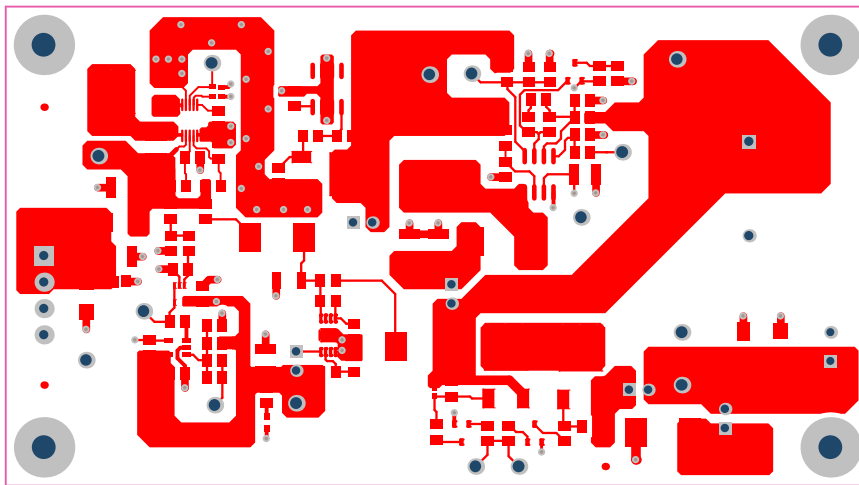
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00500	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00500		
PLOT NAME = Top Overlay	GENERATED : 9/15/2015	10:40:51 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00500	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Paste	TID #: TIDA-00500		
PLOT NAME = Top Paste	GENERATED : 9/15/2015 10:40:52 AM	TEXAS INSTRUMENTS	



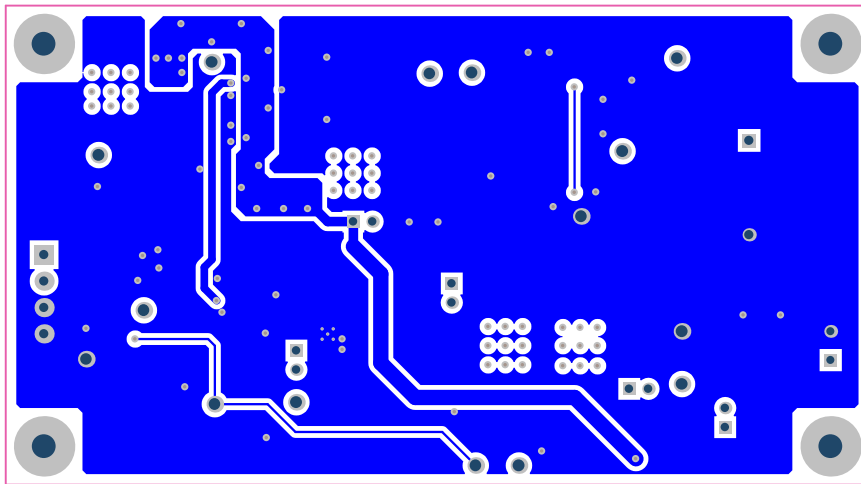
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00500	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00500		
PLOT NAME = Top Solder Mask	GENERATED : 9/15/2015 10:40:53 AM	TEXAS INSTRUMENTS	



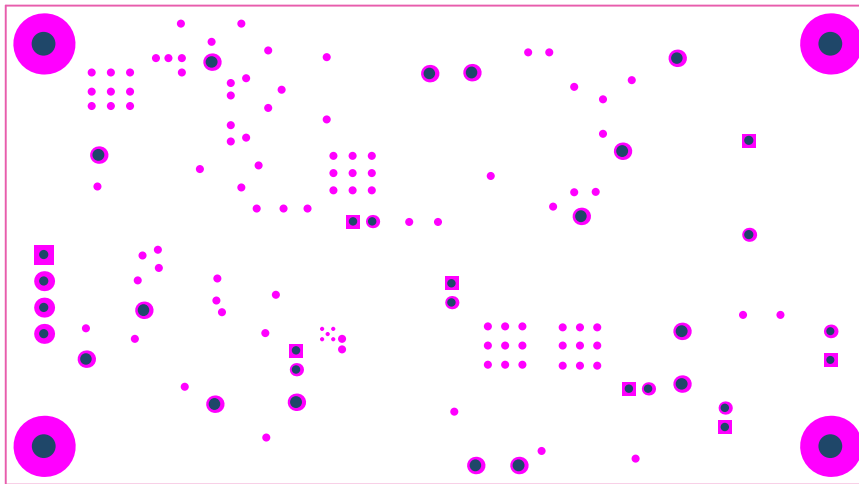
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00500	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00500		
PLOT NAME = Top Layer	GENERATED : 9/15/2015 10:40:54 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00500	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Paste	TID #: TIDA-00500		
PLOT NAME = Bottom paste	GENERATED : 9/15/2015 10:40:55 AM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00500	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00500		
PLOT NAME = Bottom Layer	GENERATED : 9/15/2015 10:40:56 AM	TEXAS INSTRUMENTS	

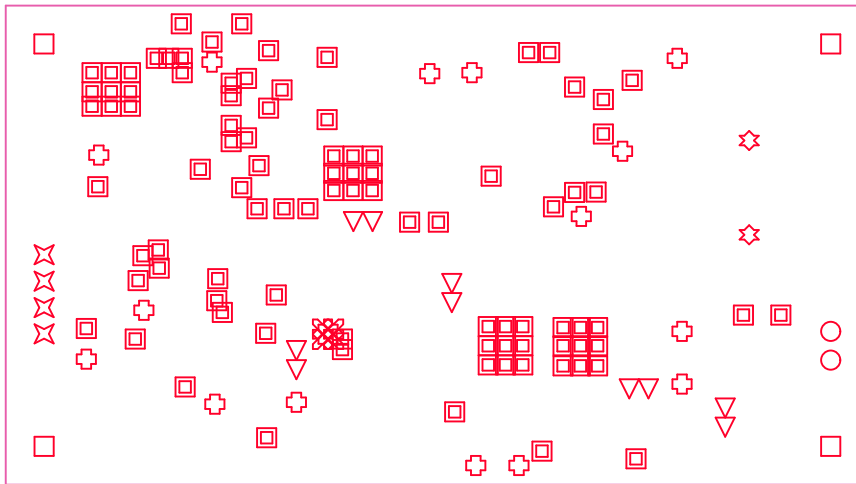


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00500	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00500		
PLOT NAME = Bottom Solder Mask	GENERATED : 9/15/2015 10:40:56 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00500	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00500		
PLOT NAME = Bottom Overlay	GENERATED : 9/15/2015 10:40:57 AM		TEXAS INSTRUMENTS

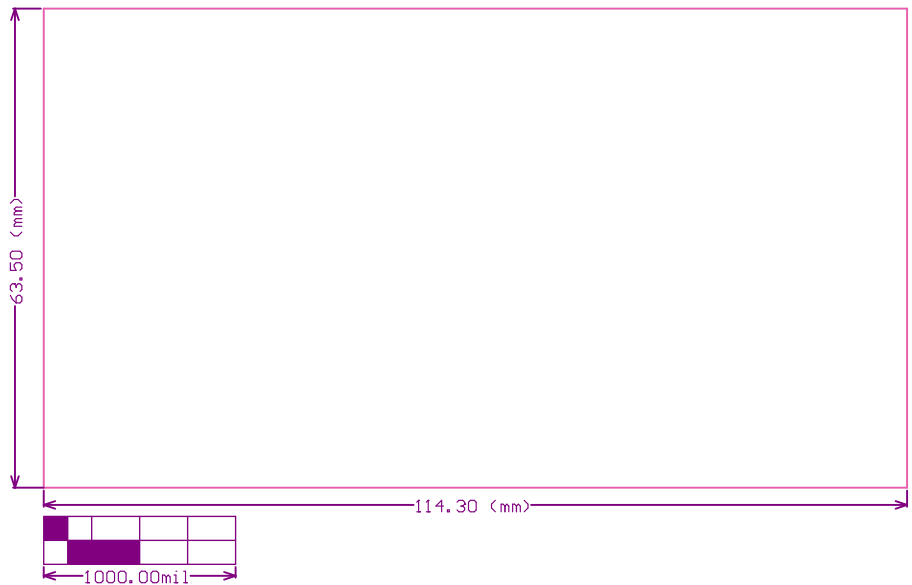




Symbol	Quantity	Finished Hole Size	Plated	Hole Type
⊗	5	7.87mil (0.200mm)	PTH	Round
■	93	20.00mil (0.508mm)	PTH	Round
○	2	43.31mil (1.100mm)	PTH	Round
▽	10	45.28mil (1.150mm)	PTH	Round
⊛	2	49.21mil (1.250mm)	PTH	Round
⊗	4	50.00mil (1.270mm)	PTH	Round
⊕	15	63.00mil (1.600mm)	PTH	Round
□	4	125.98mil (3.200mm)	PTH	Round
	135 Total			

Drill Table  
 DRILL TOLERANCE  
 FOR PTH +/- 3MIL  
 7.87mil drill: +0/-7.87mil

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00500	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00500		
PLOT NAME = Drill Drawing	GENERATED : 9/15/2015	10:40:58 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00500	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-00500		
PLOT NAME = Board Dimensions	GENERATED : 9/15/2015 10:40:58 AM	TEXAS INSTRUMENTS	

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